SN54AHCT16240, SN74AHCT16240 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCLS333I - MARCH 1996 - REVISED JANUARY 2000

- Members of the Texas Instruments Widebus™ Family
- EPIC[™] (Enhanced-Performance Implanted CMOS) Process
- Inputs Are TTL-Voltage Compatible
- Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

The 'AHCT16240 devices are 16-bit buffers and line drivers designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. They provide inverting outputs and symmetrical active-low output-enable (\overline{OE}) inputs.

SN54AHCT16240 . . . WD PACKAGE SN74AHCT16240 . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)

		1 1	1
1 <mark>OE</mark>	[1	48	2 <u>OE</u>
1Y1	2	47] 1A1
1Y2	[]3	46	1A2
GND	4	45] GND
1Y3	5	44] 1A3
1Y4	6	43] 1A4
V_{CC}	Q 7	42] v _{cc}
2Y1	8	41	2A1
2Y2	_	40	2A2
GND	10	39	GND
2Y3	11	38	
2Y4	12	37	2A4
3Y1	13	36	
3Y2	14	35	3A2
GND	_	34	
3Y3	16	33	3A3
3Y4	17	32	
V_{CC}		31	□ v _{cc}
4Y1	_	30	_
4Y2	_	29	_
GND	_	28	P
4Y3		27	Ρ
4Y4	_	26	
40E	24	25	3 <u>OE</u>

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHCT16240 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74AHCT16240 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each 4-bit buffer/driver)

INP	JTS	OUTPUT
OE	Α	Υ
L	Н	L
L	L	Н
Н	Χ	Z



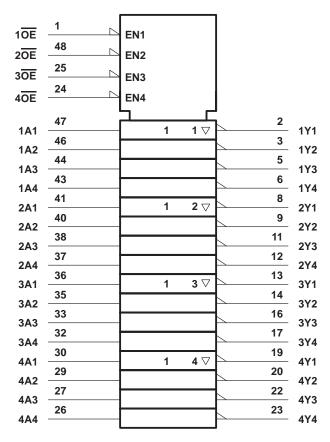
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TEXAS INSTRUMENTS

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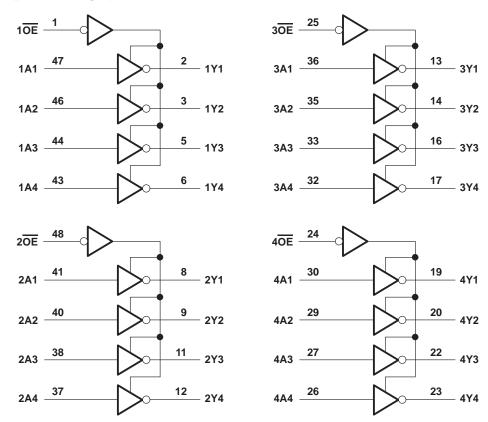
logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} —0.5 V to 7 Input voltage range, V_{I} (see Note 1) —0.5 V to 7 Output voltage range, V_{O} (see Note 1) —0.5 V to V_{CC} + 0.5 Input clamp current, I_{IK} (V_{I} < 0) —20 m Output clamp current, I_{OK} (V_{O} < 0 or V_{O} > V_{CC}) ±20 m Continuous output current, I_{O} (V_{O} = 0 to V_{CC}) ±25 m Continuous current through each V_{CC} or GND ±75 m Package thermal impedance, θ_{JA} (see Note 2): DGG package 58°C/DI package 58°C/DI package
DL package

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



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SCLS333I - MARCH 1996 - REVISED JANUARY 2000

recommended operating conditions (see Note 3)

		SN54AHC	T16240	SN74AHC	UNIT	
		MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	2	2		V
V _{IL}	Low-level input voltage		8.0		0.8	V
VI	Input voltage	0 4	5.5	0	5.5	V
Vo	Output voltage	0	VCC	0	Vcc	V
loh	High-level output current	2	-8		-8	mA
loL	Low-level output current	20%	8		8	mA
Δt/Δν	Input transition rise or fall rate	Q	20		20	ns/V
TA	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T _A = 25°C			SN54AHCT16240		SN74AHCT16240		UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
Vall	I _{OH} = -50 μA	4.5 V	4.4	4.5		4.4		4.4		V
VOH	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		3.8		V
Vol	I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	V
VOL	$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.44		0.44	V
Ι _Ι	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1	5	±1*		±1	μΑ
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.25	1	±2.5		±2.5	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4	25	40		40	μΑ
∆l _{CC} †	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			1.35	PRO.	1.5		1.5	mA
Ci	V _I = V _{CC} or GND	5 V		2.5	10				10	pF
Co	$V_O = V_{CC}$ or GND	5 V		3						pF

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

[†]This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

SCLS333I - MARCH 1996 - REVISED JANUARY 2000

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	Վ = 25° C	;	SN54AHC	T16240	SN74AHC	T16240	LINUT														
PARAMETER	(INPUT)	(OUTPUT)	T) CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT														
^t PLH	А	Y	C _I = 15 pF		5.4*	8.5*	1*	10*	1	9.5	ns														
^t PHL	K	Ţ	CL = 15 pr		5.4*	8.5*	1*	10*	1	9.5	115														
^t PZH	ŌĒ	Y	0. 455		7.7*	10.4*	1*	12*	1	12															
t _{PZL}	OE	'	C _L = 15 pF		7.7*	10.4*	1*	12*	1	12	ns														
^t PHZ	ŌĒ	Υ	v				V	C _I = 15 pF		8.3*	10.4*	1*	12*	1	12	ns									
t _{PLZ}	OE		OL = 15 pr		8.3*	10.4*	1* 6	12*	1	12	115														
^t PLH	Α	Y	Y C _L = 50 pF		7	9.5	1	11	1	10.5	ns														
^t PHL	^			'	'					ı '	'	ı '	'	'	'	'	'	ο _L = 30 με	OL = 30 pi		5.9	9.5	77	11	1
^t PZH	ŌĒ	Y	C _L = 50 pF		8.2	11.4	O 1	13	1	13	nc														
t _{PZL}	OE	'	CL = 30 pr		8.2	11.4	1	13	1	13	ns														
^t PHZ	ŌĒ	0.	Y	C _I = 50 pF		8.8	11.4	1	13	1	13	ns													
tPLZ		· ·	GL = 50 pr		8.8	11.4	1	13	1	13	115														
^t sk(o)			C _L = 50 pF			1**				1	ns														

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 5 \text{ V}$, $C_L = 50 \text{ pF}$, $T_A = 25^{\circ}\text{C}$ (see Note 4)

	PARAMETER -				UNIT
					UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.6		V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.6		V
V _{OH(V)}	Quiet output, minimum dynamic VOH		4.6		V
V _{IH(D)}	High-level dynamic input voltage	2			V
V _{IL(D)}	Low-level dynamic input voltage			0.8	V

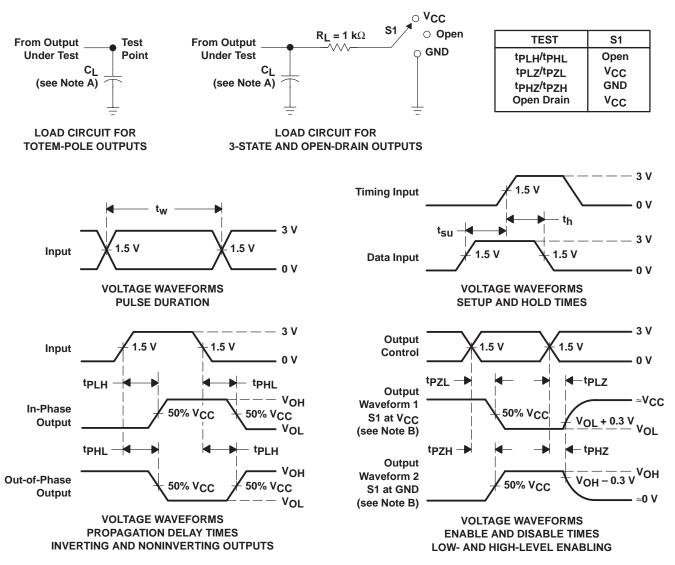
NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	No load, f = 1 MHz	10	pF

^{**} On products compliant to MIL-PRF-38535, this parameter does not apply.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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